Field Effect Transistor

Silicon N Channel MOS Type (π-MOS II)

High Speed, High Current DC-DC Converter, Relay Drive and Motor Drive Applications

Features

- Low Drain-Source ON Resistance
  - $R_{DS(ON)}$ = 3.0Ω (Typ.)
- High Forward Transfer Admittance
  - $|Y_{fs}|$ = 1.5S (Typ.)
- Low Leakage Current
  - I_{DSS} = 300μA (Max.) @ V_{DS} = 600V
- Enhancement-Mode
  - V_{th} = 2.0 ~ 4.0V @ V_{DS} = 10V, I_D = 1mA

Absolute Maximum Ratings (Ta = 25C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Drain-Source Voltage		V_{DSS}	600	V
Drain-Gate Voltage (R_{GS} = 20kΩ)		V_{DGR}	600	V
Gate-Source Voltage		V_{GSS}	±30	V
Drain Current	DC	I_D	2	A
	Pulse	I_{DP}	8	
Drain Power Dissipation (Tc = 25°C)		P_D	15	W
Channel Temperature		T_{ch}	150	°C
Storage Temperature Range		T_{stg}	-55 ~ 150	°C

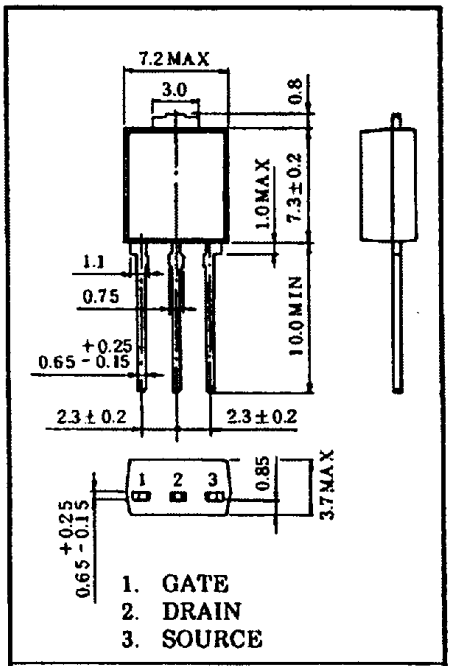
Thermal Characteristics

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel to Case	$R_{th(ch-c)}$	8.33	°C/W
Thermal Resistance, Channel to Ambient	$R_{th(ch-a)}$	96.2	°C/W

This transistor is an electrostatic sensitive device. Please handle with care.

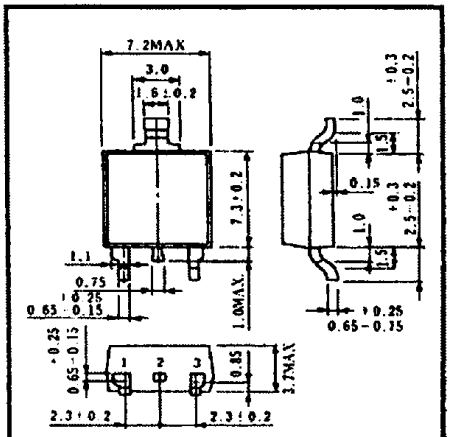
Industrial Applications

Straight Unit in mm



JEDEC	—
EIAJ	—
TOSHIBA	2-7F1B

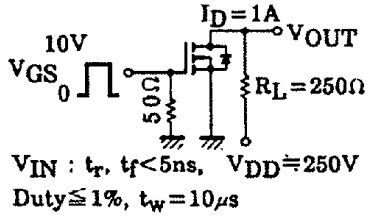
LB Unit in mm



JEDEC	—
EIAJ	—
TOSHIBA	2-7F101B

Weight : 0.6g

Electrical Characteristics (Ta = 25℃)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		I_{GSS}	V_{GS} = ±25V, V_{DS} = 0V	–	–	±100	nA
Drain Cut-off Current		I_{DSS}	V_{DS} = 600V, V_{GS} = 0V	–	–	300	μA
Drain-Source Breakdown Voltage		$V_{(BR)\ DSS}$	I_D = 10mA, V_{GS} = 0V	600	–	–	V
Gate Threshold Voltage		V_{th}	V_{DS} = 10V, I_D = 1mA	2.0	–	4.0	V
Drain-Source ON Resistance		$R_{DS\ (ON)}$	I_D = 1A, V_{GS} = 10V	–	3.0	4.0	Ω
Forward Transfer Admittance		$\|Y_{fs}\|$	V_{DS} = 10V, I_D = 1A	1.0	1.5	–	S
Input Capacitance		C_{iss}	V_{DS} = 10V, V_{GS} = 0V, f = 1MHz	–	410	600	pF
Reverse Transfer Capacitance		C_{rss}		–	80	160	
Output Capacitance		C_{oss}		–	180	250	
Switching Time	Rise Time	t_r	 V_{IN} : t_r, t_f < 5ns, V_{DD} ≒ 250V Duty ≦ 1%, t_w = 10μs	–	12	50	ns
	Turn-on Time	t_{on}		–	23	110	
	Fall Time	t_f		–	20	50	
	Turn-off Time	t_{off}		–	80	120	
Total Gate Charge (Gate-Source Plus Gate-Drain)		Q_g	V_{DD} = 480V, V_{GS} = 10V, I_D = 2A	–	12	20	nC
Gate-Source Charge		Q_{gs}		–	6	–	
Gate-Drain ("Miller") Charge		Q_{gd}		–	6	–	

Source-Drain Diode Ratings and Characteristics (Ta = 25℃)

CHARACTERISTICS	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	I_{DR}	–	–	–	2	A
Pulse Drain Reverse Current	I_{DRP}	–	–	–	8	A
Diode Forward Voltage	V_{DSF}	I_{DR} = 2A, V_{GS} = 0V	–	–	-1.6	V
Reverse Recovery Time	t_{rr}	I_{DR} = 2A, V_{GS} = 0V, dI_{DR}/dt = 100A/μs	–	550	–	ns
Reverse Recovered Charge	Q_{rr}		–	1.1	–	μC